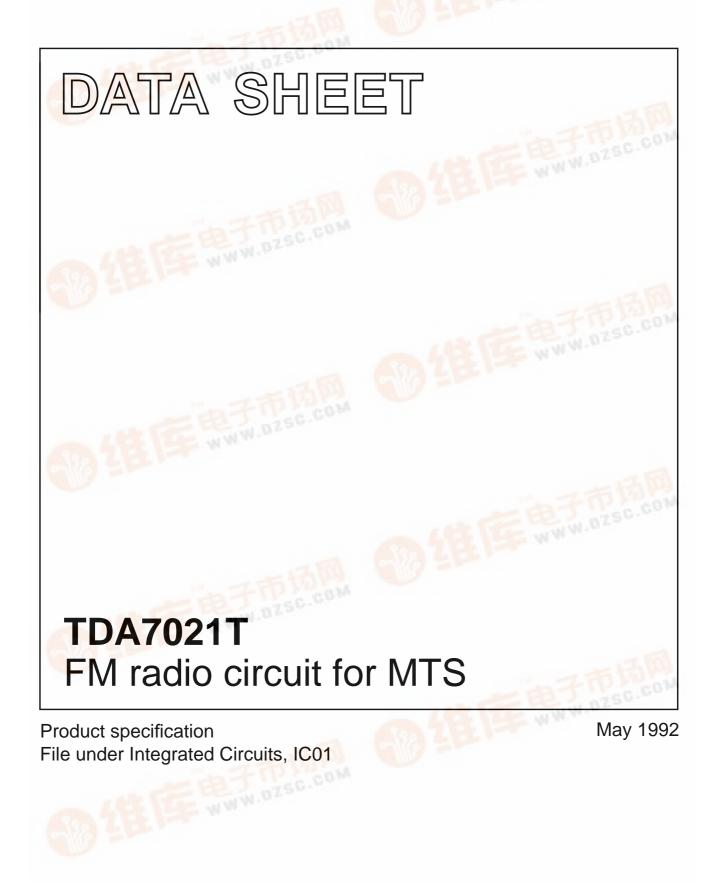
## INTEGRATED CIRCUITS









# **TDA7021T**

#### **GENERAL DESCRIPTION**

The TDA7021T integrated radio receiver circuit is for portable radios, stereo as well as mono, where a minimum of periphery is important in terms of small dimensions and low cost. It is fully compatible for applications using the low-voltage micro tuning system (MTS). The IC has a frequency locked loop (FLL) system with an intermediate frequency of 76 kHz. The selectivity is obtained by active RC filters. The only function to be tuned is the resonant frequency of the oscillator. Interstation noise as well as noise from receiving weak signals is reduced by a correlation mute system.

Special precautions have been taken to meet local oscillator radiation requirements. Because of the low intermediate frequency, low pass filtering of the MUX signal is required to avoid noise when receiving stereo. 50 kHz roll-off compensation, needed because of the low pass characteristic of the FLL, is performed by the integrated LF amplifier. For mono application this amplifier can be used to directly drive an earphone. The field-strength detector enables field-strength dependent channel separation control.

#### Features

- RF input stage
- Mixer
- · Local oscillator
- IF amplifier/limiter
- Frequency detector
- Mute circuit
- MTS compatible

#### QUICK REFERENCE DATA

- Loop amplifier
- Internal reference circuit
- LF amplifier for
  - mono earphone amplifier or
  - MUX filter
- Field-strength dependent channel separation control facility

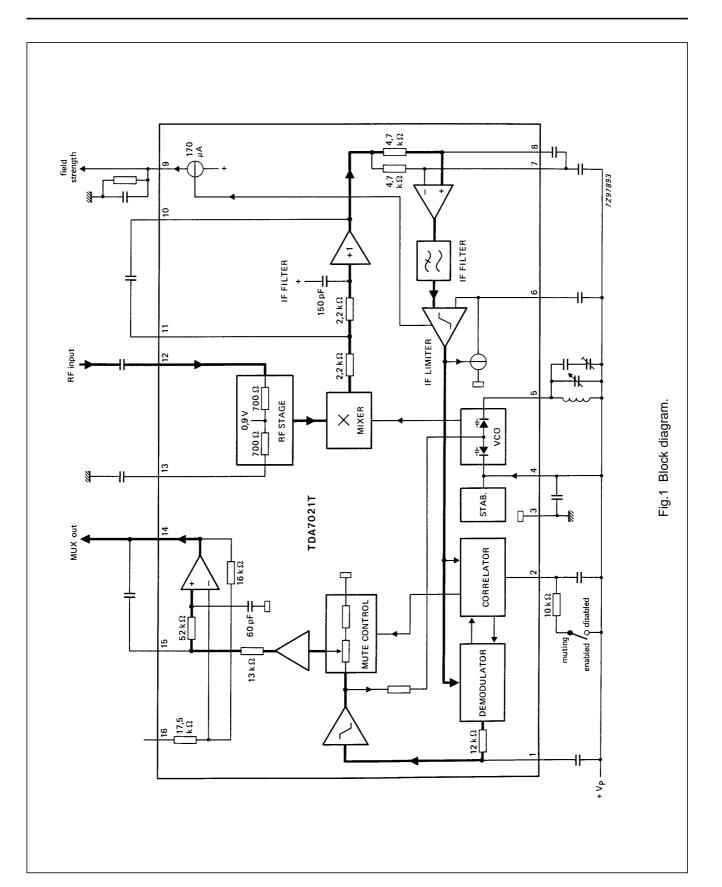
| PARAMETER                | CONDITIONS                       | SYMBOL            | MIN. | TYP. | MAX. | UNIT |
|--------------------------|----------------------------------|-------------------|------|------|------|------|
| Supply voltage (pin 4)   |                                  | $V_{P} = V_{4-3}$ | 1,8  | -    | 6,0  | V    |
| Supply current           | V <sub>P</sub> = 3 V             | I <sub>4</sub>    | -    | 6,3  | -    | mA   |
| RF input frequency       |                                  | f <sub>rf</sub>   | 1,5  | _    | 110  | MHz  |
| Sensitivity (e.m.f.) for | source impedance = 75 $\Omega$ ; |                   |      |      |      |      |
| –3 dB limiting           | mute disabled                    | EMF               | _    | 4    | _    | μV   |
| Signal handling (e.m.f.) | source impedance = 75 $\Omega$   | EMF               | _    | 200  | _    | mV   |
| AF output voltage        |                                  | Vo                | _    | 90   | _    | mV   |

### PACKAGE OUTLINE

16-lead mini-pack; plastic (SO 16; SOT109A); SOT109-1; 1996 July 24.

TDA7021T

## FM radio circuit for MTS



I

### RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| PARAMETER                           | CONDITIONS | SYMBOL            | MIN.               | MAX.                 | UNIT |
|-------------------------------------|------------|-------------------|--------------------|----------------------|------|
| Supply voltage (pin 4)              |            | $V_{P} = V_{4-3}$ | -                  | 7,0                  | V    |
| Oscillator voltage                  |            | V <sub>5-4</sub>  | V <sub>P</sub> 0,5 | V <sub>P</sub> + 0,5 | V    |
| Storage temperature range           |            | T <sub>stg</sub>  | -55                | +150                 | °C   |
| Operating ambient temperature range |            | T <sub>amb</sub>  | -10                | +70                  | °C   |

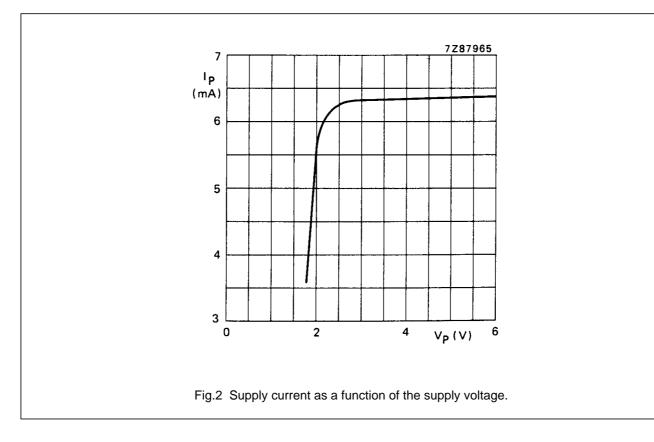
#### THERMAL RESISTANCE

From junction to ambient

### DC CHARACTERISTICS

 $V_{\text{P}}$  = 3 V,  $T_{\text{amb}}$  = 25 °C, measured in circuit of Fig.4, unless otherwise specified

| PARAMETER               | CONDITIONS           | SYMBOL            | MIN. | TYP. | MAX. | UNIT |
|-------------------------|----------------------|-------------------|------|------|------|------|
| Supply voltage (pin 4)  |                      | $V_{P} = V_{4-3}$ | 1,8  | 3,0  | 6,0  | V    |
| Supply current          | V <sub>P</sub> = 3 V | I <sub>4</sub>    | -    | 6,3  | -    | mA   |
| Oscillator current      |                      | I <sub>5</sub>    | _    | 250  | _    | μA   |
| Voltage at pin 13       |                      | V <sub>13-3</sub> | -    | 0,9  | -    | V    |
| Output voltage (pin 14) |                      | V <sub>14-3</sub> | _    | 1,3  | _    | V    |



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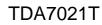


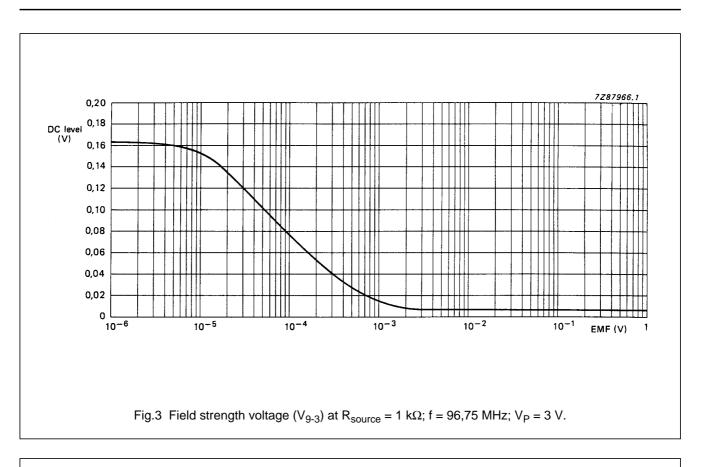
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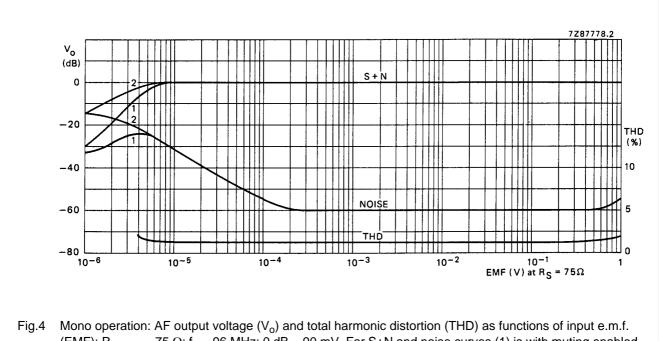
### AC CHARACTERISTICS (MONO OPERATION)

 $V_P$  = 3 V;  $T_{amb}$  = 25 °C; measured in Fig.5;  $f_{rf}$  = 96 MHz modulated with  $\Delta f$  = ±22,5 kHz;  $f_m$  = 1 kHz; EMF = 0,3 mV (e.m.f. at a source impedance of 75  $\Omega$ ); r.m.s. noise voltage measured unweighted (f = 300 Hz to 20 kHz); unless otherwise specified

| PARAMETER                                    | CONDITIONS                                  | SYMBOL                                 | MIN. | TYP. | MAX.    | UNIT   |
|--|---|--|------|------|---------|--------|
| Sensitivity (e.m.f.)                         | see Fig.3                                   |  |      |      |         |        |
| for –3 dB limiting                           | muting disabled                             | EMF                                    | -    | 4,0  | -       | μV     |
| for –3 dB muting                             |   | EMF                                    | _    | 5,0  | -       | μV     |
| for $(S+N)/N = 26 \text{ dB}$                |   | EMF                                    | _    | 7,0  | -       | μV     |
| Signal handling (e.m.f.)                     | THD < 10%;                                  |  |      |      |         |        |
|  | $\Delta f = \pm 75 \text{ kHz}$             | EMF                                    | _    | 200  | -       | mV     |
| Signal-to-noise ratio                        |   | (S+N)/N                                | _    | 60   | -       | dB     |
| Total harmonic distortion                    | $\Delta f = \pm 22,5 \text{ kHz}$           | THD                                    | _    | 0,7  | -       | %      |
|  | $\Delta f = \pm 75 \text{ kHz}$             | THD                                    | _    | 2,3  | -       | %      |
| AM suppression of output                     |   |  |      |      |         |        |
| voltage                                      | ratio of AM signal                          |  |      |      |         |        |
|  | (f <sub>m</sub> = 1 kHz; m = 80%)           |  |      |      |         |        |
|  | to FM signal (f <sub>m</sub> =              |  |      |      |         |        |
|  | 1 kHz; ∆f = 75 kHz)                         | AMS                                    | _    | 50   | -       | dB     |
| Ripple rejection                             | $\Delta V_P = 100 \text{ mV};$              |  |      |      |         |        |
|  | f = 1 kHz                                   | RR                                     | _    | 30   | -       | dB     |
| Oscillator voltage (r.m.s. value)            |   | V <sub>5-4(rms)</sub>                  | _    | 250  | -       | mV     |
| Variation of oscillator frequency            |   | - ( - /                                |      |      |         |        |
| with temperature                             | V <sub>P</sub> = 1 V                        | $\Delta f_{osc}$                       | _    | 5    | -       | kHz/°C |
|  |   | $\Delta T_{amb}$                       |      |      |         |        |
| Selectivity                                  | see Fig.9;                                  | ano                                    |      |      |         |        |
| Selectivity                                  | no modulation                               | 0                                      |      | 46   |         | dB     |
|  |   | S <sub>+300</sub><br>S <sub>-300</sub> | -    | 30   | -<br> _ | dВ     |
| AFC range                                    |   | $\frac{S_{-300}}{\pm \Delta f_{rf}}$   | -    | 160  | _       | кНz    |
| Mute range                                   |   | $\pm \Delta f_{rf}$                    | _    | 120  | _       | kHz    |
| Audio bandwidth                              | $\Delta V_{o} = 3 \text{ dB};$              | ±Δ1 rf                                 | -    | 120  | -       | KIIZ   |
|  | $\Delta v_0 = 3$ GB,<br>measured with 50 µs |  |      |      |         |        |
|  |   |  |      | 10   |         | kHz    |
| AF output voltage                            | pre-emphasis                                | В                                      | -    | 10   | -       |        |
|  | D (nin 14) 100 $O$                          |  |      |      |         |        |
| (r.m.s. value) $R_L$ (pin 14) = 100 $\Omega$ |   | V <sub>o(rms)</sub>                    | -    | 90   | -       | mV     |
| AF output current                            |   |  | 100  |      | 1100    |        |
| max. d.c. load                               |   | l <sub>o(dc)</sub>                     | -100 | -    | +100    | μA     |
| max. a.c. load (peak value)                  | THD = 10%                                   | I <sub>o(ac)</sub>                     | -    | 3    | -       | mA     |

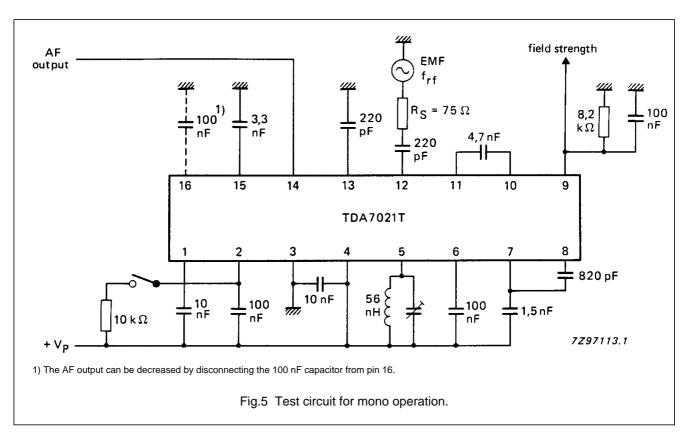






(EMF);  $R_{source} = 75 \Omega$ ;  $f_{ff} = 96$  MHz; 0 dB = 90 mV. For S+N and noise curves (1) is with muting enabled and (2) is with muting disabled; signal  $\Delta f = \pm 22,5$  kHz and  $f_m = 1$  kHz. For THD curve,  $\Delta f = \pm 75$  kHz and  $f_m = 1$  kHz.

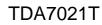
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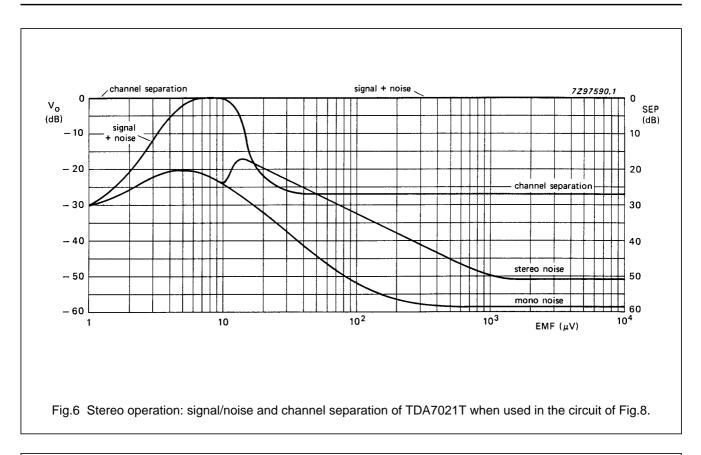


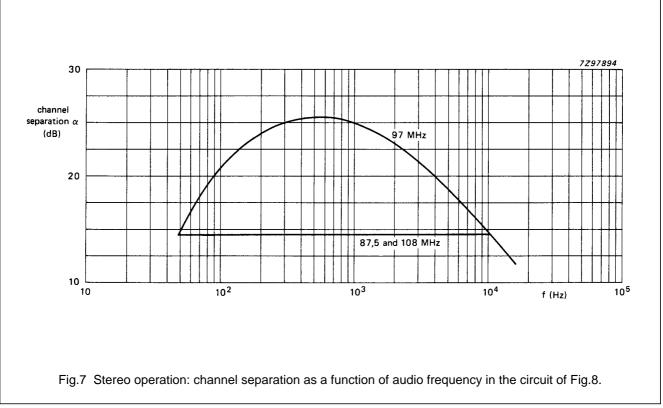
### AC CHARACTERISTICS (STEREO OPERATION)

 $V_P$  = 3 V;  $T_{amb}$  = 25 °C; measured in Fig.8;  $f_{rf}$  = 96 MHz modulated with pilot  $\Delta f = \pm 6,75$  kHz and AF signal  $\Delta f = \pm 22,5$  kHz;  $f_m$  = 1 kHz; EMF = 1 mV (e.m.f. at a source impedance of 75  $\Omega$ ); r.m.s. noise voltage measured unweighted (f = 300 Hz to 20 kHz); unless otherwise specified

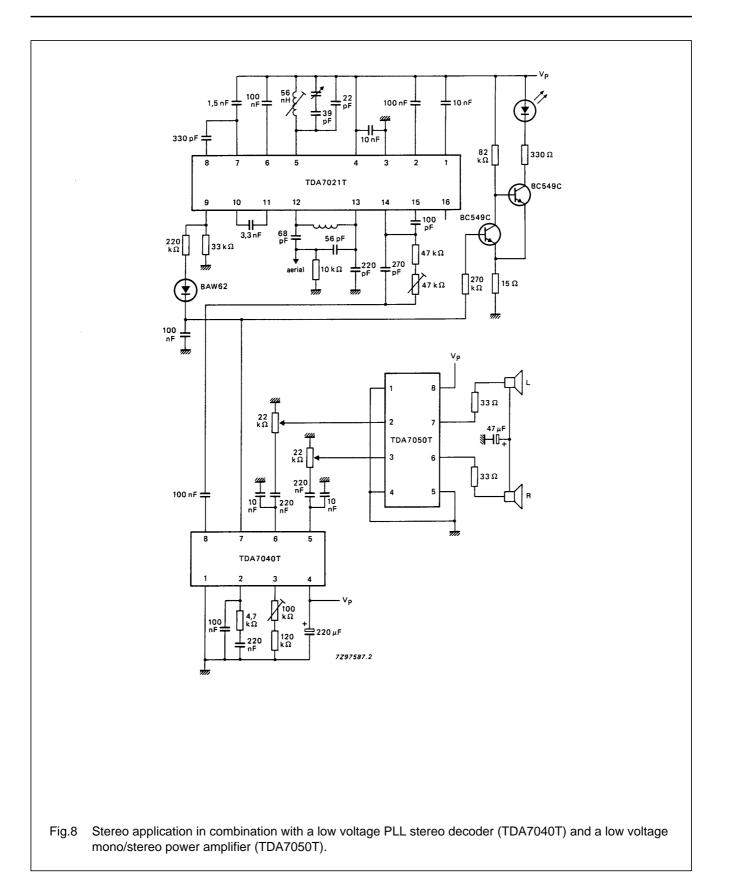
| PARAMETER                     | CONDITIONS   | SYMBOL            | MIN. | TYP. | MAX. | UNIT |
|-------------------------------|--|-------------------|------|------|------|------|
| Sensitivity (e.m.f.)          |  |                   |      |      |      |      |
| for $(S+N)/N = 26 \text{ dB}$ | see Fig.8; pilot off                                 | EMF               | _    | 11   | _    | μV   |
| Selectivity                   | see Fig.9; no modulation                             | S <sub>+300</sub> | _    | 40   | _    | dB   |
|                               |  | S <sub>-300</sub> | _    | 22   | _    | dB   |
| Signal-to-noise ratio         |  | (S+N)/N           | _    | 50   | _    | dB   |
| Channel separation            | $V_i = L$ -signal; $f_m = 1 \text{ kHz}$ ; pilot on: |                   |      |      |      |      |
|                               | at f <sub>rf</sub> = 97 MHz                          | α                 | _    | 26   | _    | dB   |
|                               | at f <sub>rf</sub> = 87,5 MHz and 108 MHz            | α                 | _    | 14   | -    | dB   |



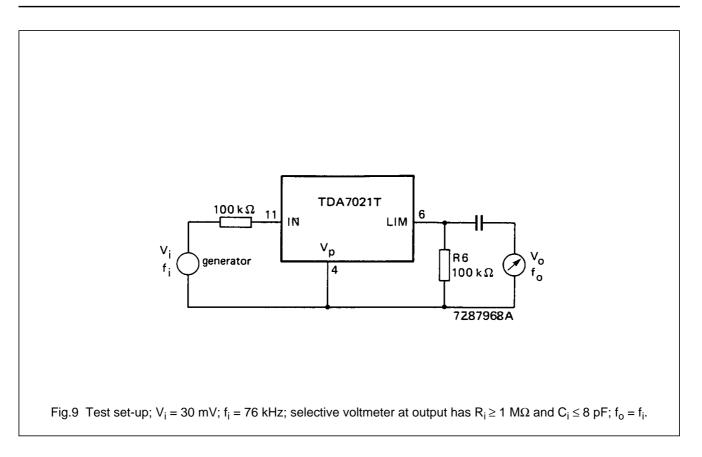




# TDA7021T



## TDA7021T



### Note to Fig. 9

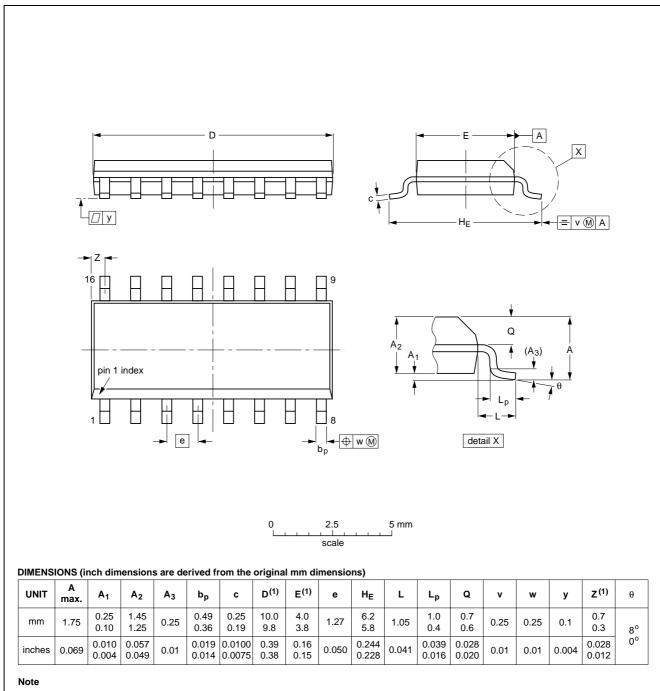
This test set-up is to incorporate the circuit of Fig.5 for mono operation or the circuit of Fig.8 for stereo operation. For either circuit, replace the 100 nF capacitor at pin 6 with R6 (100 k $\Omega$ ) as shown above.

#### Selectivity

$$S_{+300} = 20 \log \frac{V_o | (300 \text{ kHz} - f_i)}{V_o | f_i} \qquad S_{-300} = 20 \log \frac{V_o | (300 \text{ kHz} + f_i)}{V_o | f_i}$$

### PACKAGE OUTLINE

### SO16: plastic small outline package; 16 leads; body width 3.9 mm



1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE  | REFERENCES |          |      | EUROPEAN | ISSUE DATE |                                 |
|----------|------------|----------|------|----------|------------|---------------------------------|
| VERSION  | IEC        | JEDEC    | EIAJ |          | PROJECTION | ISSUE DATE                      |
| SOT109-1 | 076E07S    | MS-012AC |      |          |            | <del>95-01-23</del><br>97-05-22 |

**TDA7021T** 

# TDA7021T

#### SOLDERING

#### Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

#### **Reflow soldering**

Reflow soldering techniques are suitable for all SO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

#### Wave soldering

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### **Repairing soldered joints**

Fix the component by first soldering two diagonallyopposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

# TDA7021T

### DEFINITIONS

| Data sheet status   |  |  |  |  |
|---|--|--|--|--|
| Objective specification                                     | This data sheet contains target or goal specifications for product development.  |  |  |  |
| Preliminary specification                                   | This data sheet contains preliminary data; supplementary data may be published later.  |  |  |  |
| Product specification                                       | This data sheet contains final product specifications.   |  |  |  |
| Limiting values   |  |  |  |  |
| more of the limiting values<br>of the device at these or at | accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or<br>may cause permanent damage to the device. These are stress ratings only and operation<br>any other conditions above those given in the Characteristics sections of the specification<br>limiting values for extended periods may affect device reliability. |  |  |  |
| Application information                                     |  |  |  |  |
|   |  |  |  |  |

Where application information is given, it is advisory and does not form part of the specification.

### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.